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Data sheet acquired from Harris Semiconductor  
SCHS173C

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捷多邦，专业PCB打样工厂，24小时加急出货

**CD54HC259, CD74HC259,  
CD54HCT259, CD74HCT259**

## High-Speed CMOS Logic 8-Bit Addressable Latch

### Features

- Buffered Inputs and Outputs
- Four Operating Modes
- Typical Propagation Delay of 15ns at  $V_{CC} = 5V$ ,  $C_L = 15pF$ ,  $T_A = 25^\circ C$
- Fanout (Over Temperature Range)
  - Standard Outputs ..... 10 LSTTL Loads
  - Bus Driver Outputs ..... 15 LSTTL Loads
- Wide Operating Temperature Range ...  $-55^\circ C$  to  $125^\circ C$
- Balanced Propagation Delay and Transition Times
- Significant Power Reduction Compared to LSTTL Logic ICs
- HC Types
  - 2V to 6V Operation
  - High Noise Immunity:  $N_{IL} = 30\%$ ,  $N_{IH} = 30\%$  of  $V_{CC}$  at  $V_{CC} = 5V$
- HCT Types
  - 4.5V to 5.5V Operation
  - Direct LSTTL Input Logic Compatibility,  $V_{IL} = 0.8V$  (Max),  $V_{IH} = 2V$  (Min)
  - CMOS Input Compatibility,  $I_I \leq 1\mu A$  at  $V_{OL}, V_{OH}$

### Description

The 'HC259 and 'HCT259 Addressable Latch features the low-power consumption associated with CMOS circuitry and has speeds comparable to low-power Schottky.

This latches three active modes and one reset mode. When both the Latch Enable ( $\overline{LE}$ ) and Master Reset ( $\overline{MR}$ ) inputs are low (8-line Demultiplexer mode) the output of the addressed latch follows the Data input and all other outputs are forced low. When both  $\overline{MR}$  and  $\overline{LE}$  are high (Memory Mode), all outputs are isolated from the Data input, i.e., all latches hold the last data presented before the  $\overline{LE}$  transition from low to high. A condition of  $\overline{LE}$  low and  $\overline{MR}$  high (Addressable Latch mode) allows the addressed latch's output to follow the data input; all other latches are unaffected. The Reset mode (all outputs low) results when  $\overline{LE}$  is high and  $\overline{MR}$  is low.

### Ordering Information

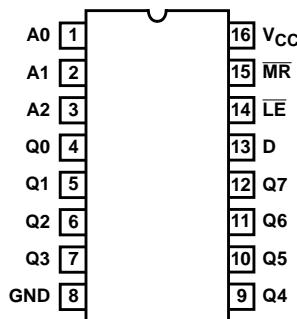
| PART NUMBER   | TEMP. RANGE (°C) | PACKAGE      |
|---------------|------------------|--------------|
| CD54HC259F3A  | -55 to 125       | 16 Ld CERDIP |
| CD54HCT259F3A | -55 to 125       | 16 Ld CERDIP |
| CD74HC259E    | -55 to 125       | 16 Ld PDIP   |
| CD74HC259M    | -55 to 125       | 16 Ld SOIC   |
| CD74HC259MT   | -55 to 125       | 16 Ld SOIC   |
| CD74HC259M96  | -55 to 125       | 16 Ld SOIC   |
| CD74HCT259E   | -55 to 125       | 16 Ld PDIP   |
| CD74HCT259M   | -55 to 125       | 16 Ld SOIC   |
| CD74HCT259MT  | -55 to 125       | 16 Ld SOIC   |
| CD74HCT259M96 | -55 to 125       | 16 Ld SOIC   |

NOTE: When ordering, use the entire part number. The suffix 96 denotes tape and reel. The suffix T denotes a small-quantity reel of 250.

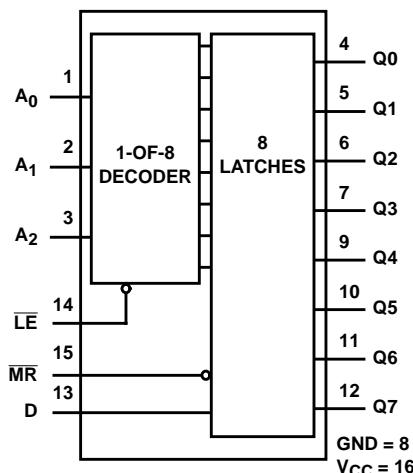
## CD54HC259, CD74HC259, CD54HCT259, CD74HCT259

### Pinout

**CD54HC259, CD54HCT259  
(CERDIP)  
CD74HC259, CD74HCT259  
(PDIP, SOIC)**  
 TOP VIEW



### Functional Diagram



TRUTH TABLE

| INPUTS |    | OUTPUT OF<br>ADDRESS<br>LATCH | EACH OTHER<br>OUTPUT | FUNCTION             |
|--------|----|-------------------------------|----------------------|----------------------|
| MR     | LE |                               |                      |                      |
| H      | L  | D                             | Q <sub>io</sub>      | Addressable Latch    |
| H      | H  | Q <sub>io</sub>               | Q <sub>io</sub>      | Memory               |
| L      | L  | D                             | L                    | 8-Line Demultiplexer |
| L      | H  | L                             | L                    | Reset                |

H = High Voltage Level

L = Low Voltage Level

D = The level at the data input

Q<sub>io</sub> = The level of Q<sub>i</sub> (i = 0, 1...7, as appropriate) before the indicated steady-state input conditions were established.

LATCH SELECTION TABLE

| SELECT INPUTS |    |    | LATCH<br>ADDRESSED |
|---------------|----|----|--------------------|
| A2            | A1 | A0 |                    |
| L             | L  | L  | 0                  |
| L             | L  | H  | 1                  |
| L             | H  | L  | 2                  |
| L             | H  | H  | 3                  |
| H             | L  | L  | 4                  |
| H             | L  | H  | 5                  |
| H             | H  | L  | 6                  |
| H             | H  | H  | 7                  |

# CD54HC259, CD74HC259, CD54HCT259, CD74HCT259

## Absolute Maximum Ratings

|   |       |             |
|---|-------|-------------|
| DC Supply Voltage, V <sub>CC</sub>  | ..... | -0.5V to 7V |
| DC Input Diode Current, I <sub>IK</sub>                                   |       |             |
| For V <sub>I</sub> < -0.5V or V <sub>I</sub> > V <sub>CC</sub> + 0.5V     | ..... | ±20mA       |
| DC Output Diode Current, I <sub>OK</sub>                                  |       |             |
| For V <sub>O</sub> < -0.5V or V <sub>O</sub> > V <sub>CC</sub> + 0.5V     | ..... | ±20mA       |
| DC Drain Current, per Output, I <sub>O</sub>                              |       |             |
| For -0.5V < V <sub>O</sub> < V <sub>CC</sub> + 0.5V                       | ..... | ±25mA       |
| DC Output Source or Sink Current per Output Pin, I <sub>O</sub>           |       |             |
| For V <sub>O</sub> > -0.5V or V <sub>O</sub> < V <sub>CC</sub> + 0.5V     | ..... | ±25mA       |
| DC V <sub>CC</sub> or Ground Current, I <sub>CC</sub> or I <sub>GND</sub> | ..... | ±50mA       |

## Thermal Information

|  |  |
|--|--|
| Thermal Resistance (Typical, Note 1)     | θ <sub>JA</sub> (°C/W)                 |
| E (PDIP) Package                         | ..... 67                               |
| M (SOIC) Package                         | ..... 73                               |
| Maximum Junction Temperature             | ..... 150°C                            |
| Maximum Storage Temperature Range        | ..... -65°C to 150°C                   |
| Maximum Lead Temperature (Soldering 10s) | ..... 300°C<br>(SOIC - Lead Tips Only) |

## Operating Conditions

|   |       |                       |
|---|-------|-----------------------|
| Temperature Range, T <sub>A</sub>                           | ..... | -55°C to 125°C        |
| Supply Voltage Range, V <sub>CC</sub>                       |       |                       |
| HC Types  | ..... | .2V to 6V             |
| HCT Types   | ..... | .4.5V to 5.5V         |
| DC Input or Output Voltage, V <sub>I</sub> , V <sub>O</sub> | ..... | 0V to V <sub>CC</sub> |
| Input Rise and Fall Time                                    |       |                       |
| 2V  | ..... | 1000ns (Max)          |
| 4.5V  | ..... | 500ns (Max)           |
| 6V  | ..... | 400ns (Max)           |

**CAUTION:** Stresses above those listed in "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress only rating and operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied.

### NOTE:

1. The package thermal impedance is calculated in accordance with JESD 51-7.

## DC Electrical Specifications

| PARAMETER                            | SYMBOL          | TEST CONDITIONS                    |                     | V <sub>CC</sub> (V) | 25°C |     |      | -40°C TO 85°C |      | -55°C TO 125°C |      | UNITS |  |
|--------------------------------------|-----------------|------------------------------------|---------------------|---------------------|------|-----|------|---------------|------|----------------|------|-------|--|
|                                      |                 | V <sub>I</sub> (V)                 | I <sub>O</sub> (mA) |                     | MIN  | TYP | MAX  | MIN           | MAX  | MIN            | MAX  |       |  |
| <b>HC TYPES</b>                      |                 |                                    |                     |                     |      |     |      |               |      |                |      |       |  |
| High Level Input Voltage             | V <sub>IH</sub> | -                                  | -                   | 2                   | 1.5  | -   | -    | 1.5           | -    | 1.5            | -    | V     |  |
|                                      |                 |                                    |                     | 4.5                 | 3.15 | -   | -    | 3.15          | -    | 3.15           | -    | V     |  |
|                                      |                 |                                    |                     | 6                   | 4.2  | -   | -    | 4.2           | -    | 4.2            | -    | V     |  |
| Low Level Input Voltage              | V <sub>IL</sub> | -                                  | -                   | 2                   | -    | -   | 0.5  | -             | 0.5  | -              | 0.5  | V     |  |
|                                      |                 |                                    |                     | 4.5                 | -    | -   | 1.35 | -             | 1.35 | -              | 1.35 | V     |  |
|                                      |                 |                                    |                     | 6                   | -    | -   | 1.8  | -             | 1.8  | -              | 1.8  | V     |  |
| High Level Output Voltage CMOS Loads | V <sub>OH</sub> | V <sub>IH</sub> or V <sub>IL</sub> | -0.02               | 2                   | 1.9  | -   | -    | 1.9           | -    | 1.9            | -    | V     |  |
|                                      |                 |                                    | -0.02               | 4.5                 | 4.4  | -   | -    | 4.4           | -    | 4.4            | -    | V     |  |
|                                      |                 |                                    | -0.02               | 6                   | 5.9  | -   | -    | 5.9           | -    | 5.9            | -    | V     |  |
| High Level Output Voltage TTL Loads  |                 |                                    | -                   | -                   | -    | -   | -    | -             | -    | -              | -    | V     |  |
|                                      |                 |                                    | -4                  | 4.5                 | 3.98 | -   | -    | 3.84          | -    | 3.7            | -    | V     |  |
|                                      |                 |                                    | -5.2                | 6                   | 5.48 | -   | -    | 5.34          | -    | 5.2            | -    | V     |  |
| Low Level Output Voltage CMOS Loads  | V <sub>OL</sub> | V <sub>IH</sub> or V <sub>IL</sub> | 0.02                | 2                   | -    | -   | 0.1  | -             | 0.1  | -              | 0.1  | V     |  |
|                                      |                 |                                    | 0.02                | 4.5                 | -    | -   | 0.1  | -             | 0.1  | -              | 0.1  | V     |  |
|                                      |                 |                                    | 0.02                | 6                   | -    | -   | 0.1  | -             | 0.1  | -              | 0.1  | V     |  |
| Low Level Output Voltage TTL Loads   |                 |                                    | -                   | -                   | -    | -   | -    | -             | -    | -              | -    | V     |  |
|                                      |                 |                                    | 4                   | 4.5                 | -    | -   | 0.26 | -             | 0.33 | -              | 0.4  | V     |  |
|                                      |                 |                                    | 5.2                 | 6                   | -    | -   | 0.26 | -             | 0.33 | -              | 0.4  | V     |  |
| Input Leakage Current                | I <sub>I</sub>  | V <sub>CC</sub> or GND             | -                   | 6                   | -    | -   | ±0.1 | -             | ±1   | -              | ±1   | µA    |  |

## CD54HC259, CD74HC259, CD54HCT259, CD74HCT259

### DC Electrical Specifications (Continued)

| PARAMETER  | SYMBOL                    | TEST CONDITIONS                    |                     | V <sub>CC</sub> (V) | 25°C |     |      | -40°C TO 85°C |      | -55°C TO 125°C |     | UNITS |
|--|---------------------------|------------------------------------|---------------------|---------------------|------|-----|------|---------------|------|----------------|-----|-------|
|  |                           | V <sub>I</sub> (V)                 | I <sub>O</sub> (mA) |                     | MIN  | TYP | MAX  | MIN           | MAX  | MIN            | MAX |       |
| Quiescent Device Current                                       | I <sub>CC</sub>           | V <sub>CC</sub> or GND             | 0                   | 6                   | -    | -   | 8    | -             | 80   | -              | 160 | µA    |
| <b>HCT TYPES</b>   |                           |                                    |                     |                     |      |     |      |               |      |                |     |       |
| High Level Input Voltage                                       | V <sub>IH</sub>           | -                                  | -                   | 4.5 to 5.5          | 2    | -   | -    | 2             | -    | 2              | -   | V     |
| Low Level Input Voltage  | V <sub>IL</sub>           | -                                  | -                   | 4.5 to 5.5          | -    | -   | 0.8  | -             | 0.8  | -              | 0.8 | V     |
| High Level Output Voltage CMOS Loads                           | V <sub>OH</sub>           | V <sub>IH</sub> or V <sub>IL</sub> | -0.02               | 4.5                 | 4.4  | -   | -    | 4.4           | -    | 4.4            | -   | V     |
| High Level Output Voltage TTL Loads                            |                           |                                    | -4                  | 4.5                 | 3.98 | -   | -    | 3.84          | -    | 3.7            | -   | V     |
| Low Level Output Voltage CMOS Loads                            | V <sub>OL</sub>           | V <sub>IH</sub> or V <sub>IL</sub> | 0.02                | 4.5                 | -    | -   | 0.1  | -             | 0.1  | -              | 0.1 | V     |
| Low Level Output Voltage TTL Loads                             |                           |                                    | 4                   | 4.5                 | -    | -   | 0.26 | -             | 0.33 | -              | 0.4 | V     |
| Input Leakage Current  | I <sub>I</sub>            | V <sub>CC</sub> and GND            | 0                   | 5.5                 | -    |     | ±0.1 | -             | ±1   | -              | ±1  | µA    |
| Quiescent Device Current                                       | I <sub>CC</sub>           | V <sub>CC</sub> or GND             | 0                   | 5.5                 | -    | -   | 8    | -             | 80   | -              | 160 | µA    |
| Additional Quiescent Device Current Per Input Pin: 1 Unit Load | ΔI <sub>CC</sub> (Note 2) | V <sub>CC</sub> -2.1               | -                   | 4.5 to 5.5          | -    | 100 | 360  | -             | 450  | -              | 490 | µA    |

NOTE:

2. For dual-supply systems theoretical worst case (V<sub>I</sub> = 2.4V, V<sub>CC</sub> = 5.5V) specification is 1.8mA.

### HCT Input Loading Table

| INPUT       | UNIT LOADS |
|-------------|------------|
| A0 - A2, LE | 1.5        |
| D           | 1.2        |
| MR          | 0.75       |

NOTE: Unit Load is ΔI<sub>CC</sub> limit specified in DC Electrical Table, e.g., 360µA max at 25°C.

### Prerequisite for Switching Specifications

| PARAMETER       | SYMBOL          | V <sub>CC</sub> (V) | 25°C |     |     | -40°C TO 85°C |     |     | -55°C TO 125°C |     |     | UNITS |
|-----------------|-----------------|---------------------|------|-----|-----|---------------|-----|-----|----------------|-----|-----|-------|
|                 |                 |                     | MIN  | TYP | MAX | MIN           | TYP | MAX | MIN            | TYP | MAX |       |
| <b>HC TYPES</b> |                 |                     |      |     |     |               |     |     |                |     |     |       |
| Pulse Width LE  | t <sub>WL</sub> |                     | 2    | 70  | -   | -             | 90  | -   | -              | 105 | -   | -     |
|                 |                 |                     | 4.5  | 14  | -   | -             | 18  | -   | -              | 21  | -   | -     |
|                 |                 |                     | 6    | 12  | -   | -             | 15  | -   | -              | 18  | -   | -     |

## CD54HC259, CD74HC259, CD54HCT259, CD74HCT259

### Prerequisite for Switching Specifications (Continued)

| PARAMETER                                      | SYMBOL          | V <sub>CC</sub> (V) | 25°C |     |     | -40°C TO 85°C |     |     | -55°C TO 125°C |     |     | UNITS |
|--|-----------------|---------------------|------|-----|-----|---------------|-----|-----|----------------|-----|-----|-------|
|  |                 |                     | MIN  | TYP | MAX | MIN           | TYP | MAX | MIN            | TYP | MAX |       |
| MR   | t <sub>WL</sub> | 2                   | 70   | -   | -   | 90            | -   | -   | 105            | -   | -   | ns    |
|  |                 | 4.5                 | 14   | -   | -   | 18            | -   | -   | 21             | -   | -   | ns    |
|  |                 | 6                   | 12   | -   | -   | 15            | -   | -   | 18             | -   | -   | ns    |
| Setup Time<br>D to <u>LE</u><br>A to <u>LE</u> | t <sub>SU</sub> | 2                   | 80   | -   | -   | 100           | -   | -   | 120            | -   | -   | ns    |
|  |                 | 4.5                 | 16   | -   | -   | 20            | -   | -   | 24             | -   | -   | ns    |
|  |                 | 6                   | 14   | -   | -   | 17            | -   | -   | 20             | -   | -   | ns    |
| Hold Time<br>D to <u>LE</u><br>A to <u>LE</u>  | t <sub>H</sub>  | 2                   | 0    | -   | -   | 0             | -   | -   | 0              | -   | -   | ns    |
|  |                 | 4.5                 | 0    | -   | -   | 0             | -   | -   | 0              | -   | -   | ns    |
|  |                 | 6                   | 0    | -   | -   | 0             | -   | -   | 0              | -   | -   | ns    |
| <b>HCT TYPES</b>                               |                 |                     |      |     |     |               |     |     |                |     |     |       |
| Pulse Width<br><u>LE</u><br>MR                 | t <sub>WL</sub> | 4.5                 | 18   | -   | -   | 23            | -   | -   | 27             | -   | -   | ns    |
| Setup Time<br>D to <u>LE</u><br>A to <u>LE</u> | t <sub>SU</sub> | 4.5                 | 17   | -   | -   | 21            | -   | -   | 26             | -   | -   | ns    |
| Hold Time<br>D to <u>LE</u><br>A to <u>LE</u>  | t <sub>H</sub>  | 4.5                 | 0    | -   | -   | 0             | -   | -   | 0              | -   | -   | ns    |

**Switching Specifications** C<sub>L</sub> = 50pF, Input t<sub>r</sub>, t<sub>f</sub> = 6ns

| PARAMETER                   | SYMBOL           | TEST CONDITIONS       | V <sub>CC</sub> (V) | 25°C |     |     | -40°C TO 85°C |     | -55°C TO 125°C |     | UNITS |
|-----------------------------|------------------|-----------------------|---------------------|------|-----|-----|---------------|-----|----------------|-----|-------|
|                             |                  |                       |                     | MIN  | TYP | MAX | MIN           | MAX | MIN            | MAX |       |
| <b>HC TYPES</b>             |                  |                       |                     |      |     |     |               |     |                |     |       |
| Propagation Delay<br>D to Q | t <sub>PHL</sub> | C <sub>L</sub> = 50pF | 2                   | -    | -   | 185 | -             | 230 | -              | 280 | ns    |
|                             |                  |                       | 4.5                 | -    | -   | 37  | -             | 46  | -              | 56  | ns    |
|                             |                  | C <sub>L</sub> = 15pF | 5                   | -    | 15  | -   | -             | -   | -              | -   | ns    |
|                             |                  | C <sub>L</sub> = 50pF | 6                   | -    | -   | 31  | -             | 39  | -              | 48  | ns    |
| LE to Q                     | t <sub>PHL</sub> | C <sub>L</sub> = 50pF | 2                   | -    | -   | 170 | -             | 215 | -              | 255 | ns    |
|                             |                  |                       | 4.5                 | -    | -   | 34  | -             | 43  | -              | 51  | ns    |
|                             |                  | C <sub>L</sub> = 15pF | 5                   | -    | 14  | -   | -             | -   | -              | -   | ns    |
|                             |                  | C <sub>L</sub> = 50pF | 6                   | -    | -   | 29  | -             | 37  | -              | 43  | ns    |

## CD54HC259, CD74HC259, CD54HCT259, CD74HCT259

**Switching Specifications**  $C_L = 50\text{pF}$ , Input  $t_r, t_f = 6\text{ns}$  (Continued)

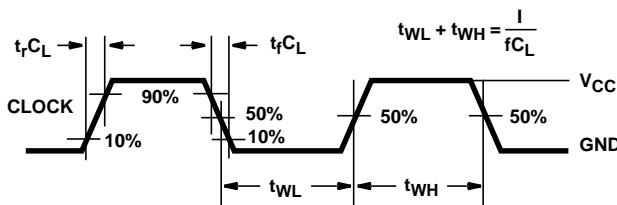
| PARAMETER                                  | SYMBOL                              | TEST CONDITIONS     | $V_{CC} (\text{V})$ | 25°C |     |     | -40°C TO 85°C |     | -55°C TO 125°C |     | UNITS |  |
|--|-------------------------------------|---------------------|---------------------|------|-----|-----|---------------|-----|----------------|-----|-------|--|
|  |                                     |                     |                     | MIN  | TYP | MAX | MIN           | MAX | MIN            | MAX |       |  |
| A to Q                                     | t <sub>PHL</sub>                    | $C_L = 50\text{pF}$ | 2                   | -    | -   | 185 | -             | 230 | -              | 280 | ns    |  |
|  |                                     |                     | 4.5                 | -    | -   | 37  | -             | 46  | -              | 56  | ns    |  |
|  |                                     | $C_L = 15\text{pF}$ | 5                   | -    | 15  | -   | -             | -   | -              | -   | ns    |  |
|  |                                     | $C_L = 50\text{pF}$ | 6                   | -    | -   | 31  | -             | 39  | -              | 48  | ns    |  |
| $\overline{MR}$ to Q                       | t <sub>PHL</sub> , t <sub>PLH</sub> | $C_L = 50\text{pF}$ | 2                   | -    | -   | 155 | -             | 195 | -              | 235 | ns    |  |
|  |                                     |                     | 4.5                 | -    | -   | 31  | -             | 39  | -              | 47  | ns    |  |
|  |                                     | $C_L = 15\text{pF}$ | 5                   | -    | 13  | -   | -             | -   | -              | -   | ns    |  |
|  |                                     | $C_L = 50\text{pF}$ | 6                   | -    | -   | 26  | -             | 33  | -              | 40  | ns    |  |
| Output Transition Time                     | t <sub>THL</sub> , t <sub>TLH</sub> | $C_L = 50\text{pF}$ | 2                   | -    | -   | 75  | -             | 95  | -              | 110 | ns    |  |
|  |                                     |                     | 4.5                 | -    | -   | 15  | -             | 19  | -              | 22  | ns    |  |
|  |                                     |                     | 6                   | -    | -   | 13  | -             | 16  | -              | 19  | ns    |  |
| Power Dissipation Capacitance (Notes 3, 4) | $C_{PD}$                            | $C_L = 15\text{pF}$ | 5                   | -    | 21  | -   | -             | -   | -              | -   | pF    |  |
| Input Capacitance                          | $C_I$                               | $C_L = 50\text{pF}$ | -                   | 10   | -   | 10  | -             | 10  | -              | 10  | pF    |  |
| <b>HCT TYPES</b>                           |                                     |                     |                     |      |     |     |               |     |                |     |       |  |
| Propagation Delay<br>D to Q                | t <sub>PHL</sub> , t <sub>PLH</sub> | $C_L = 50\text{pF}$ | 4.5                 | -    | -   | 39  | -             | 49  | -              | 59  | ns    |  |
|  |                                     |                     | $C_L = 15\text{pF}$ | 5    | -   | 16  | -             | -   | -              | -   | ns    |  |
| $\overline{LE}$ to Q                       |                                     | $C_L = 50\text{pF}$ | 4.5                 | -    | -   | 38  | -             | 48  | -              | 57  | ns    |  |
|  |                                     |                     | $C_L = 15\text{pF}$ | 5    | -   | 16  | -             | -   | -              | -   | ns    |  |
| A to Q                                     |                                     | $C_L = 50\text{pF}$ | 4.5                 | -    | -   | 41  | -             | 51  | -              | 61  | ns    |  |
|  |                                     |                     | $C_L = 15\text{pF}$ | 5    | -   | 17  | -             | -   | -              | -   | ns    |  |
| $\overline{MR}$ to Q                       |                                     | $C_L = 50\text{pF}$ | 4.5                 | -    | -   | 39  | -             | 49  | -              | 59  | ns    |  |
|  |                                     |                     | $C_L = 15\text{pF}$ | 5    | -   | 16  | -             | -   | -              | -   | ns    |  |
| Power Dissipation Capacitance (Notes 3, 4) | $C_{PD}$                            | $C_L = 15\text{pF}$ | 5                   | -    | 22  | -   | -             | -   | -              | -   | pF    |  |
| Input Capacitance                          | $C_I$                               | $C_L = 50\text{pF}$ | -                   | 10   | -   | 10  | -             | 10  | -              | 10  | pF    |  |
| Output Transition Time                     | t <sub>THL</sub> , t <sub>TLH</sub> | $C_L = 50\text{pF}$ | 4.5                 | -    | -   | 15  | -             | 19  | -              | 22  | ns    |  |

**NOTES:**

3.  $C_{PD}$  is used to determine the dynamic power consumption, per package.
4.  $P_D = C_{PD} V_{CC}^2 f_i + \sum C_L V_{CC}^2 f_O$  where  $f_i$  = Input Frequency,  $f_O$  = Output Frequency,  $C_L$  = Output Load Capacitance,  $V_{CC}$  = Supply Voltage.

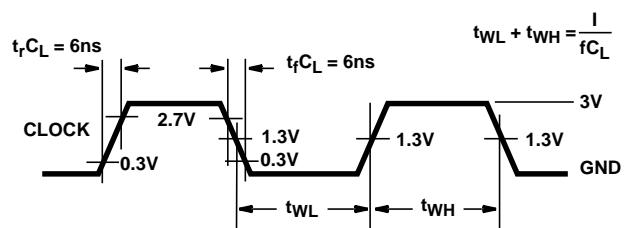
## CD54HC259, CD74HC259, CD54HCT259, CD74HCT259

### Test Circuits and Waveforms



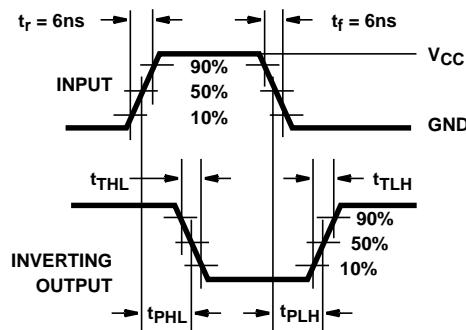
NOTE: Outputs should be switching from 10%  $V_{CC}$  to 90%  $V_{CC}$  in accordance with device truth table. For  $f_{MAX}$ , input duty cycle = 50%.

**FIGURE 1. HC CLOCK PULSE RISE AND FALL TIMES AND PULSE WIDTH**

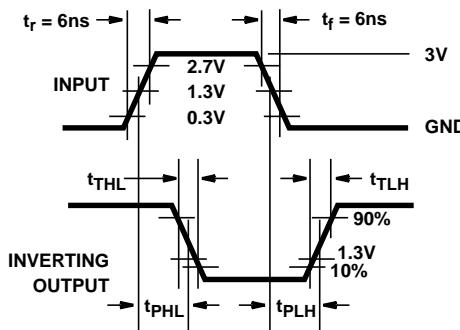


NOTE: Outputs should be switching from 10%  $V_{CC}$  to 90%  $V_{CC}$  in accordance with device truth table. For  $f_{MAX}$ , input duty cycle = 50%.

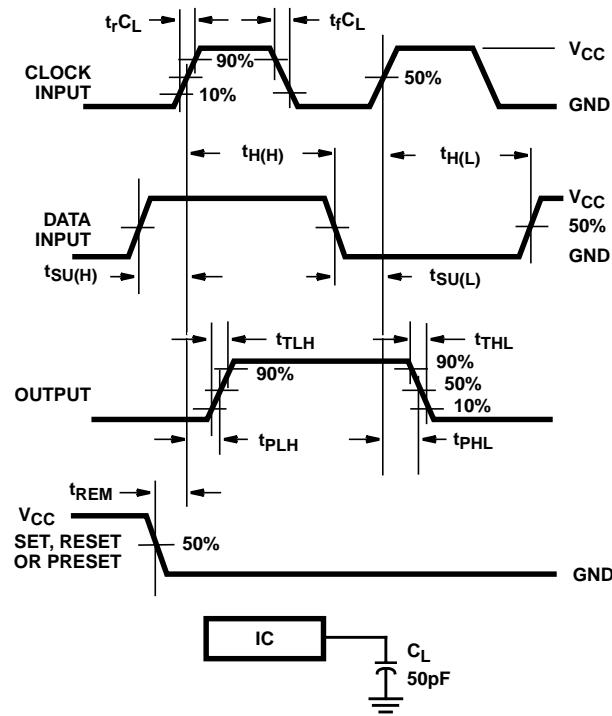
**FIGURE 2. HCT CLOCK PULSE RISE AND FALL TIMES AND PULSE WIDTH**



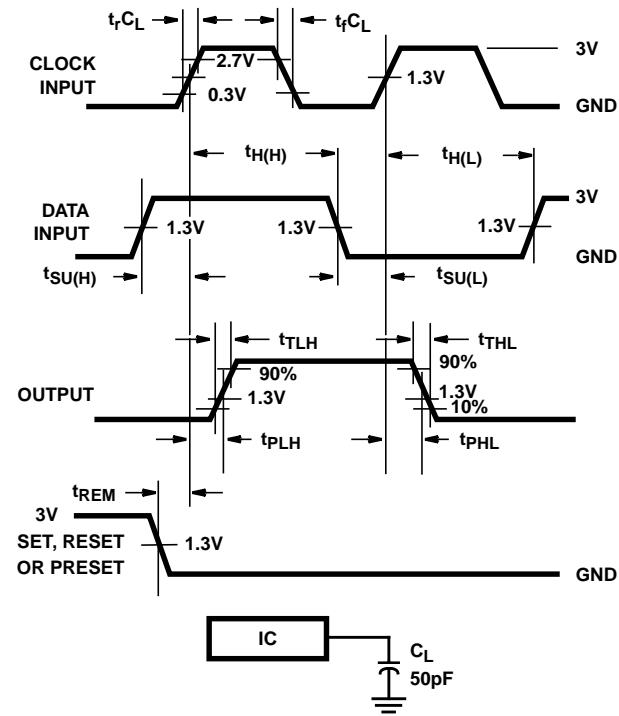
**FIGURE 3. HC TRANSITION TIMES AND PROPAGATION DELAY TIMES, COMBINATION LOGIC**



**FIGURE 4. HCT TRANSITION TIMES AND PROPAGATION DELAY TIMES, COMBINATION LOGIC**



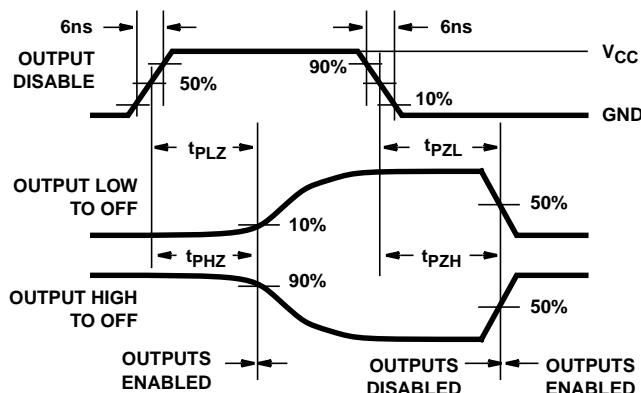
**FIGURE 5. HC SETUP TIMES, HOLD TIMES, REMOVAL TIME, AND PROPAGATION DELAY TIMES FOR EDGE TRIGGERED SEQUENTIAL LOGIC CIRCUITS**



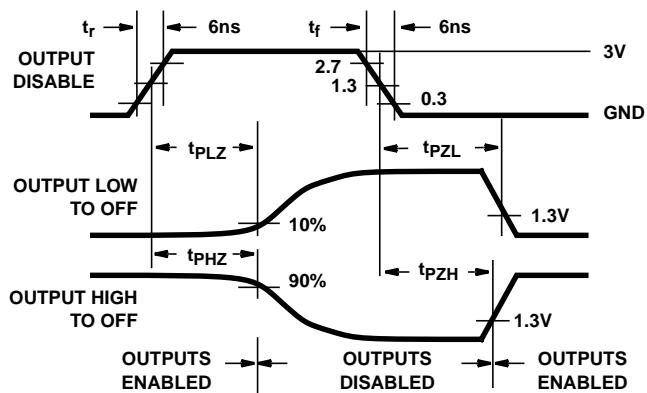
**FIGURE 6. HCT SETUP TIMES, HOLD TIMES, REMOVAL TIME, AND PROPAGATION DELAY TIMES FOR EDGE TRIGGERED SEQUENTIAL LOGIC CIRCUITS**

## CD54HC259, CD74HC259, CD54HCT259, CD74HCT259

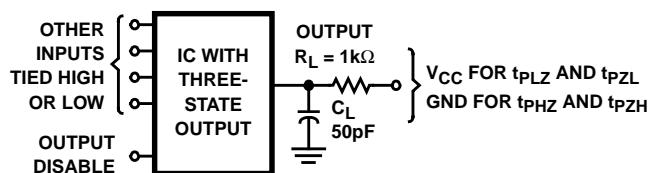
### Test Circuits and Waveforms (Continued)



**FIGURE 7. HC THREE-STATE PROPAGATION DELAY WAVEFORM**



**FIGURE 8. HCT THREE-STATE PROPAGATION DELAY WAVEFORM**



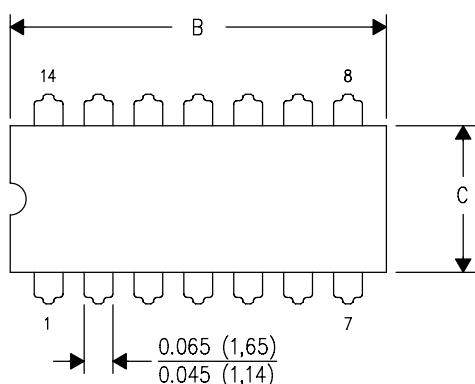
NOTE: Open drain waveforms  $t_{PLZ}$  and  $t_{PZL}$  are the same as those for three-state shown on the left. The test circuit is Output  $R_L = 1\text{k}\Omega$  to  $V_{CC}$ ,  $C_L = 50\text{pF}$ .

**FIGURE 9. HC AND HCT THREE-STATE PROPAGATION DELAY TEST CIRCUIT**

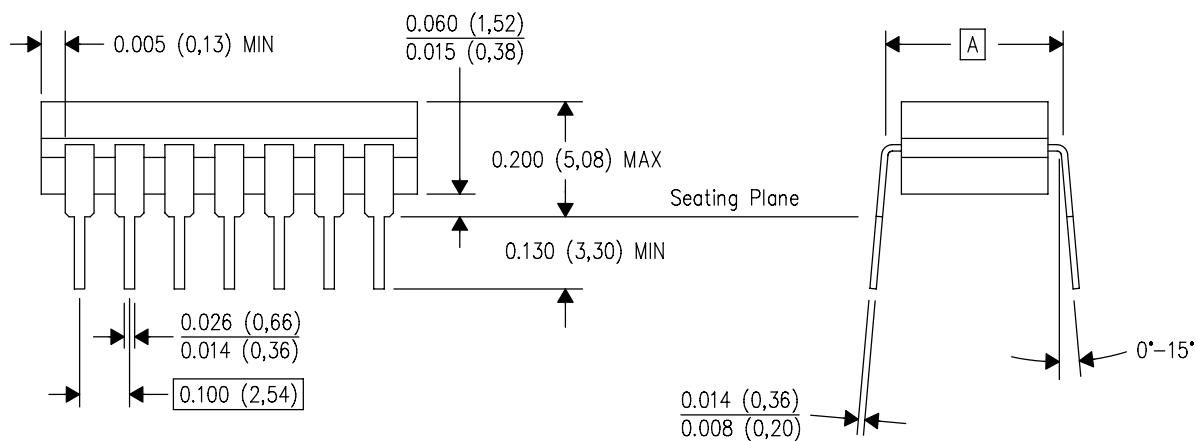
J (R-GDIP-T\*\*)

14 LEADS SHOWN

CERAMIC DUAL IN-LINE PACKAGE



| DIM \ PINS ** | 14                     | 16                     | 18                     | 20                     |
|---------------|------------------------|------------------------|------------------------|------------------------|
| A             | 0.300<br>(7,62)<br>BSC | 0.300<br>(7,62)<br>BSC | 0.300<br>(7,62)<br>BSC | 0.300<br>(7,62)<br>BSC |
| B MAX         | 0.785<br>(19,94)       | .840<br>(21,34)        | 0.960<br>(24,38)       | 1.060<br>(26,92)       |
| B MIN         | —                      | —                      | —                      | —                      |
| C MAX         | 0.300<br>(7,62)        | 0.300<br>(7,62)        | 0.310<br>(7,87)        | 0.300<br>(7,62)        |
| C MIN         | 0.245<br>(6,22)        | 0.245<br>(6,22)        | 0.220<br>(5,59)        | 0.245<br>(6,22)        |



4040083/F 03/03

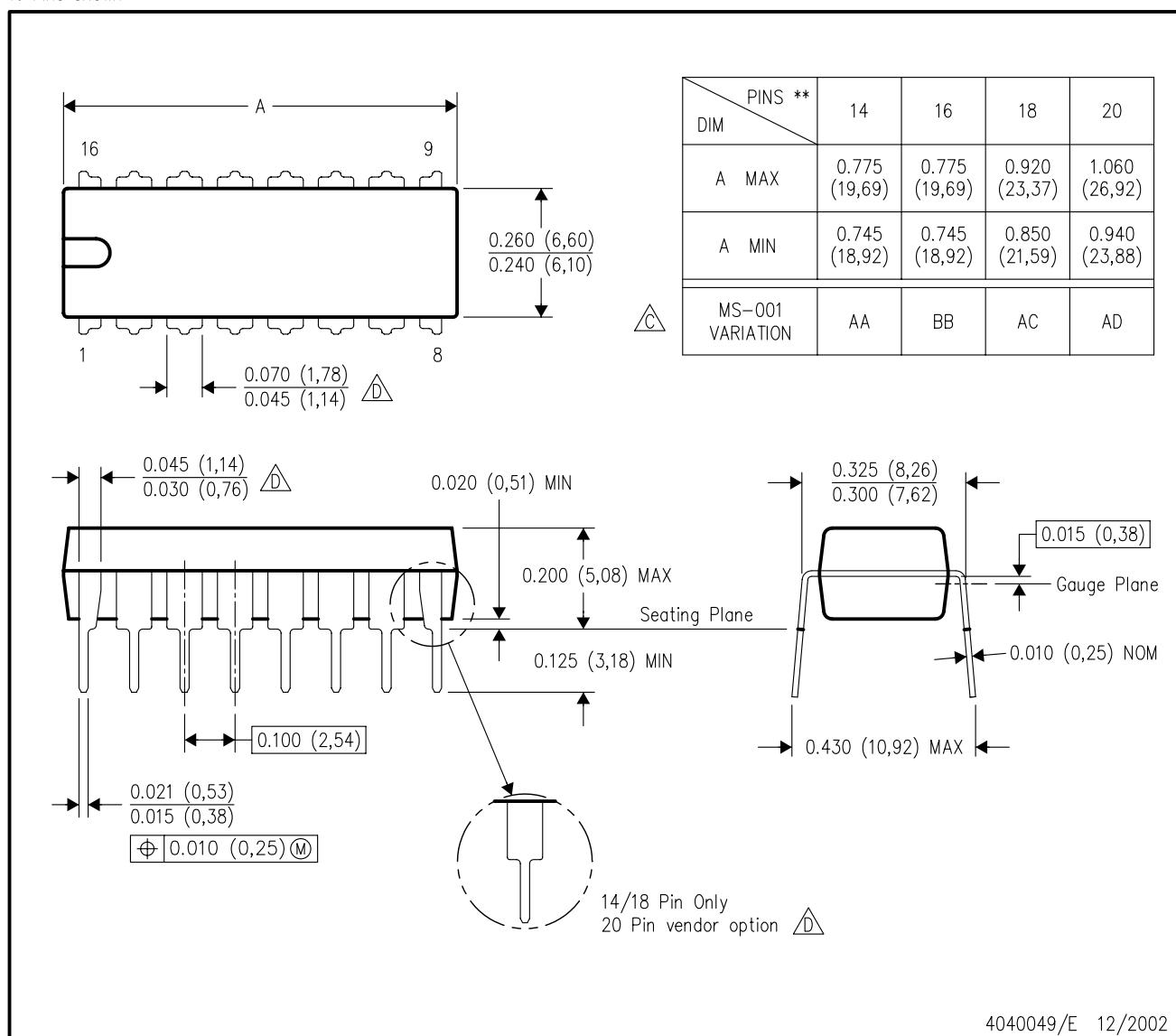
- NOTES:
- A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  - C. This package is hermetically sealed with a ceramic lid using glass frit.
  - D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
  - E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

## MECHANICAL DATA

N (R-PDIP-T\*\*)

16 PINS SHOWN

PLASTIC DUAL-IN-LINE PACKAGE



4040049/E 12/2002

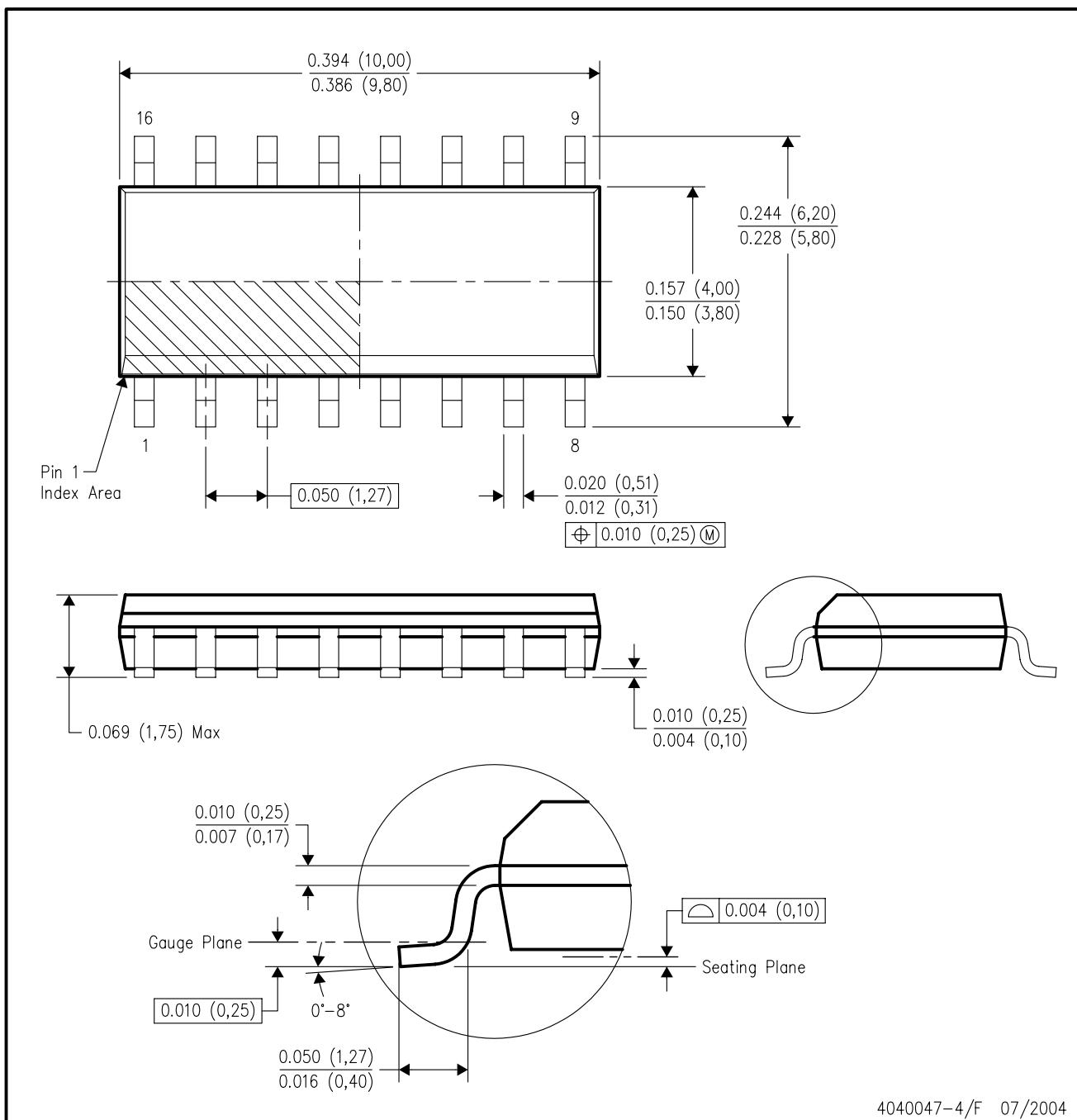
NOTES: A. All linear dimensions are in inches (millimeters).  
B. This drawing is subject to change without notice.

- △ Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).  
△ The 20 pin end lead shoulder width is a vendor option, either half or full width.

## MECHANICAL DATA

D (R-PDSO-G16)

PLASTIC SMALL-OUTLINE PACKAGE



4040047-4/F 07/2004

- NOTES:
- All linear dimensions are in inches (millimeters).
  - This drawing is subject to change without notice.
  - Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
  - Falls within JEDEC MS-012 variation AC.

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